



ACE14419T

P-Channel Enhancement Mode Power MOSFET

Description

The ACE14419T uses advanced trench technology to provide excellent R_{DS} , low gate charge and operation with gate voltages as low as 4.5V.

RoHS Compliant

Halogen Free

Features

- $V_{DS} (V) = -30V, I_D = -9.1A$
- $R_{DS(ON)} < 20m\Omega @ V_{GS} = -10V$
- $R_{DS(ON)} < 30m\Omega @ V_{GS} = -4.5V$
- SOP-8 Package

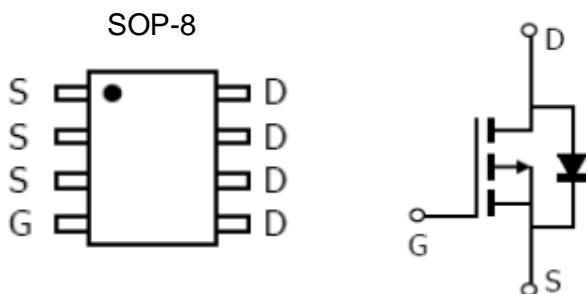
Absolute Maximum Ratings

Parameter	Symbol	Max	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current (Continuous)	I_D	-9.1	A
		-7.5	
Drain Current (Pulse)	I_{DM}	-50	
Power Dissipation	P_D	3.1	W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-case	R_{thj-c}	24	°C/W
Thermal Resistance Junction-ambient	R_{thj-a}	48	°C/W

Packaging Type



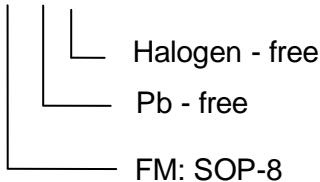


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Ordering information

ACE14419T XX + H



Electrical Characteristics

T_A=25 °C unless otherwise noted

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =-250μA	-30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V, V _{GS} =0V			-1	uA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-1	-1.5	-3	V
Gate Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-9.1A			20	mΩ
		V _{GS} =-4.5V, I _D =-6.9A			30	
Forward Trans Conductance	g _{FS}	V _{GS} =-15V, I _D =-9A	10			S
Diode Forward Voltage	V _{SD}	I _{SD} =-2.5A, V _{GS} =0V			-1.2	V
Reverse Recovery Time	trr	I _S = -7A, V _{GS} = 0V, dI/dt=100A/μs		26		ns
Reverse Recovery Charge	Qrr			17		nC
Switching						
Total Gate Charge	Q _g	V _{GS} =-10V, V _{DS} =-15V, I _D =-7A,		17		nC
Gate-Source Charge	Q _{gs}			5.3		
Gate-Drain Charge	Q _{gd}			7.9		
Turn-On Delay Time	T _{d(on)}	V _{GS} =-10V, V _{DD} =-15V, I _D =-1A, R _{GEN} =3.3Ω		8.5		ns
Turn-On Rise Time	t _f			7.5		
Turn-Off Delay Time	t _{d(off)}			42		
Turn-Off Fall Time	t _f			28		
Dynamic						
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =-15V, f=1MHz		1530		pF
Output Capacitance	C _{oss}			313		
Reverse Transfer Capacitance	C _{rss}			281		

Pulse Test: Pulse Width ≤ 300s, Duty Cycle ≤ 2.0%



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Typical Performance Characteristics

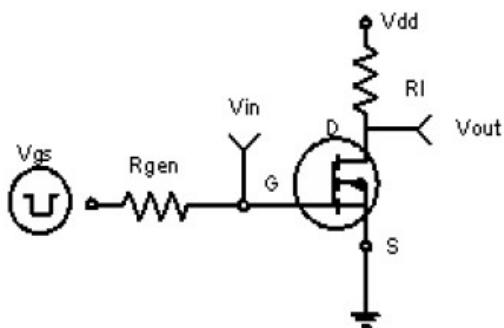


Figure 1:Switching Test Circuit

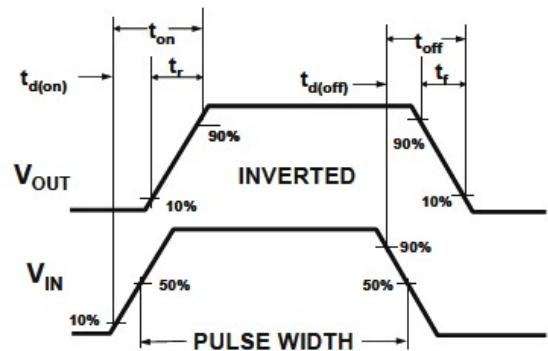
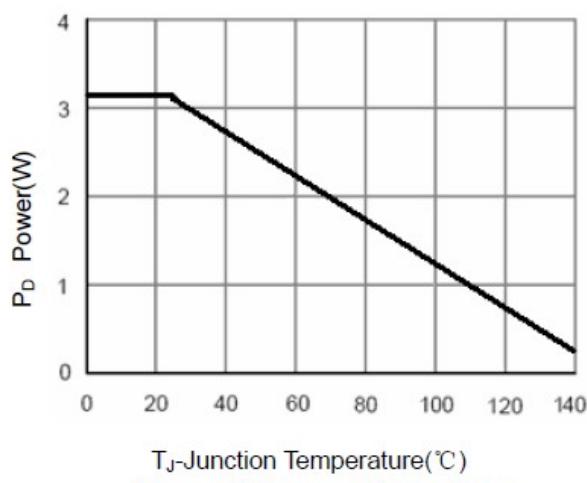
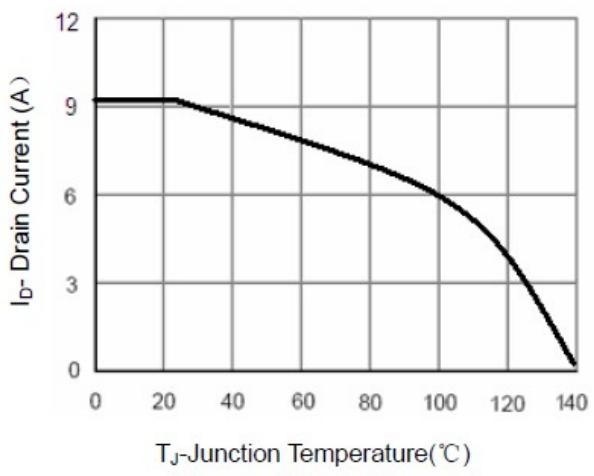


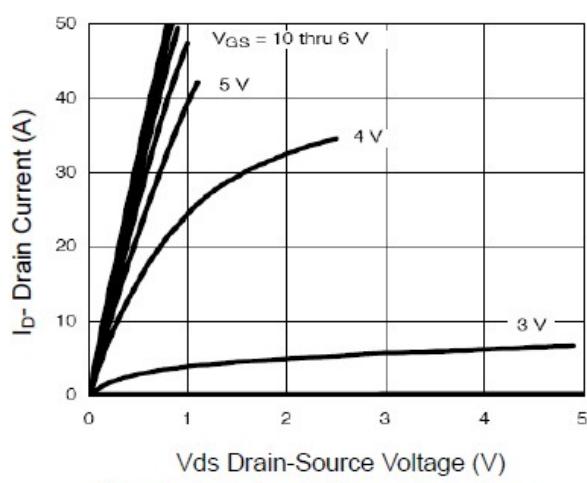
Figure 2:Switching Waveforms



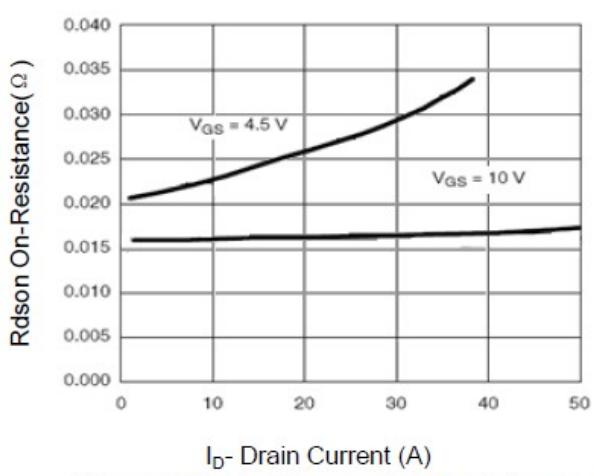
T_J-Junction Temperature(°C)
Figure 3 Power Dissipation



T_J-Junction Temperature(°C)
Figure 4 Drain Current



V_{DS} Drain-Source Voltage (V)
Figure 5 Output Characteristics



I_D- Drain Current (A)
Figure 6 Drain-Source On-Resistance



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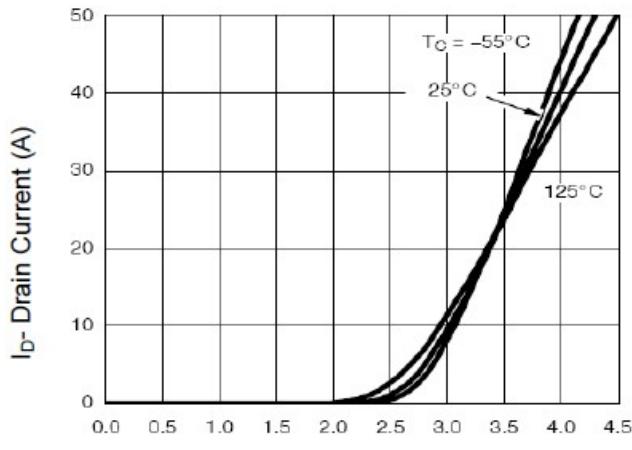


Figure 7 Transfer Characteristics

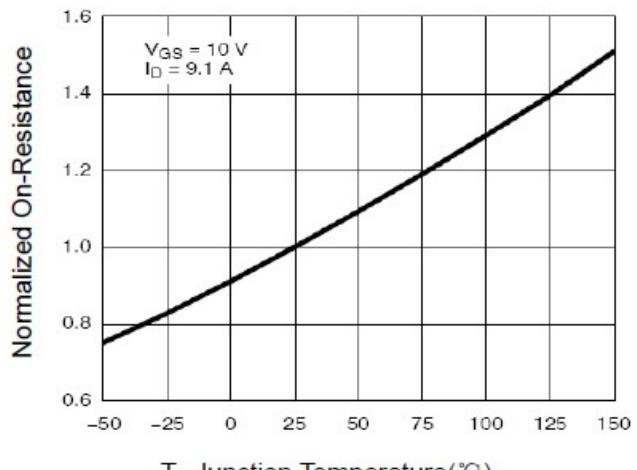


Figure 8 Drain-Source On-Resistance

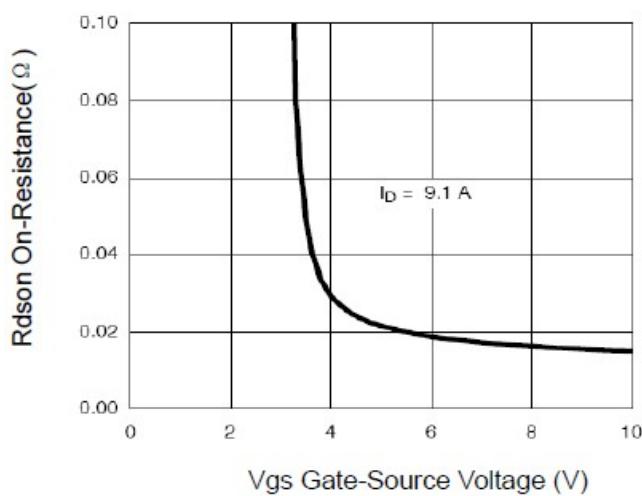


Figure 9 $R_{DS(on)}$ vs V_{GS}

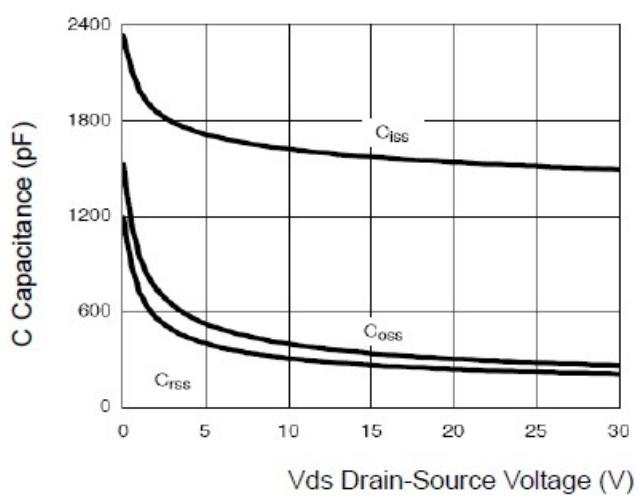


Figure 10 Capacitance vs V_{DS}

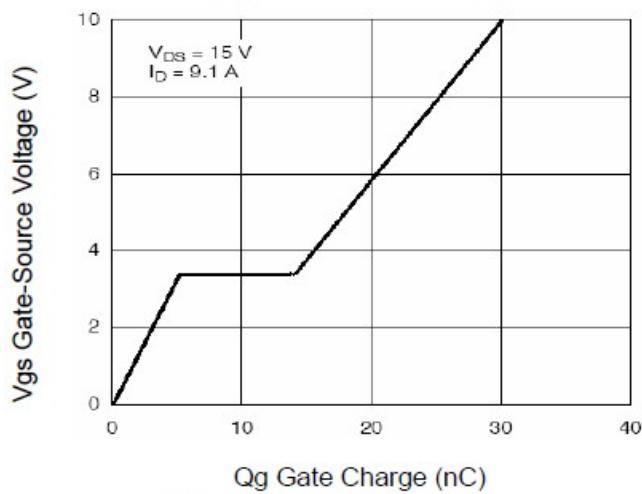


Figure 11 Gate Charge

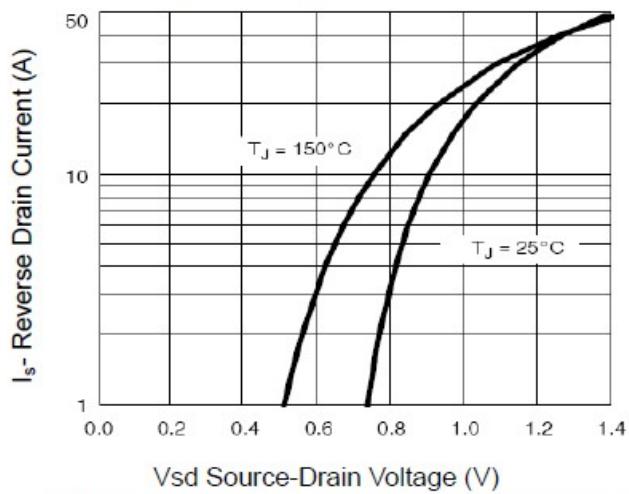


Figure 12 Source-Drain Diode Forward



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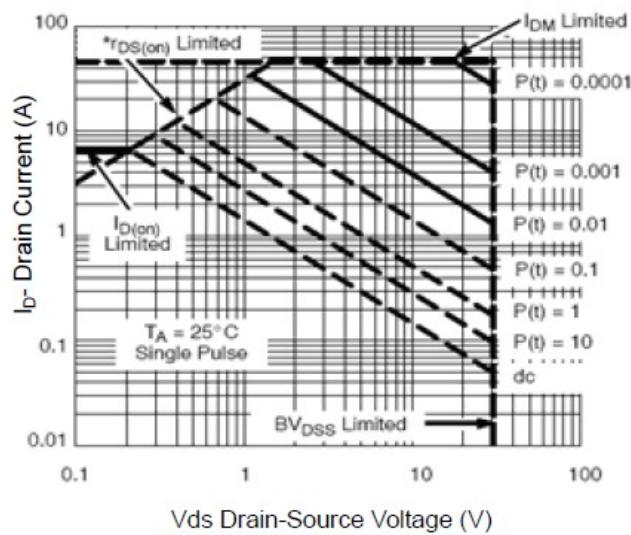


Figure 13 Safe Operation Area

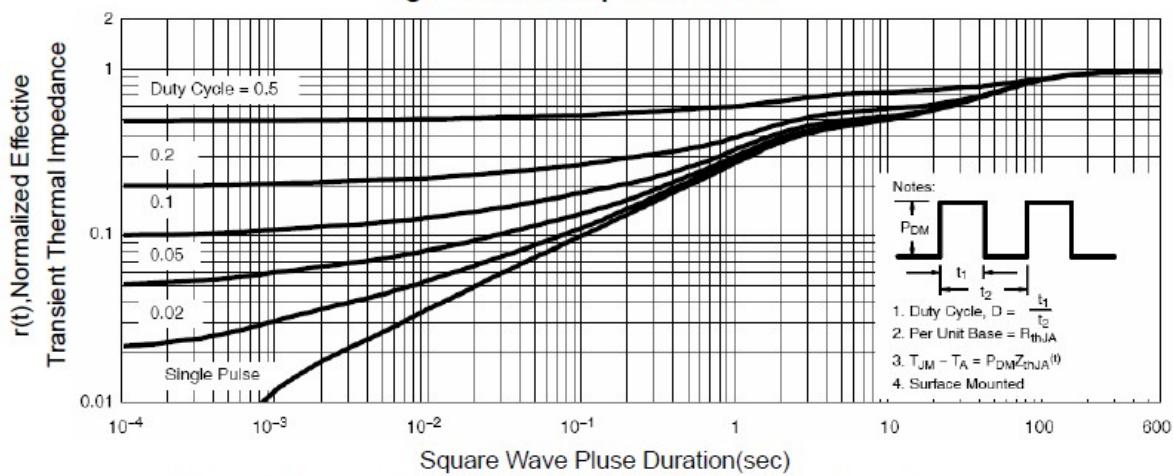


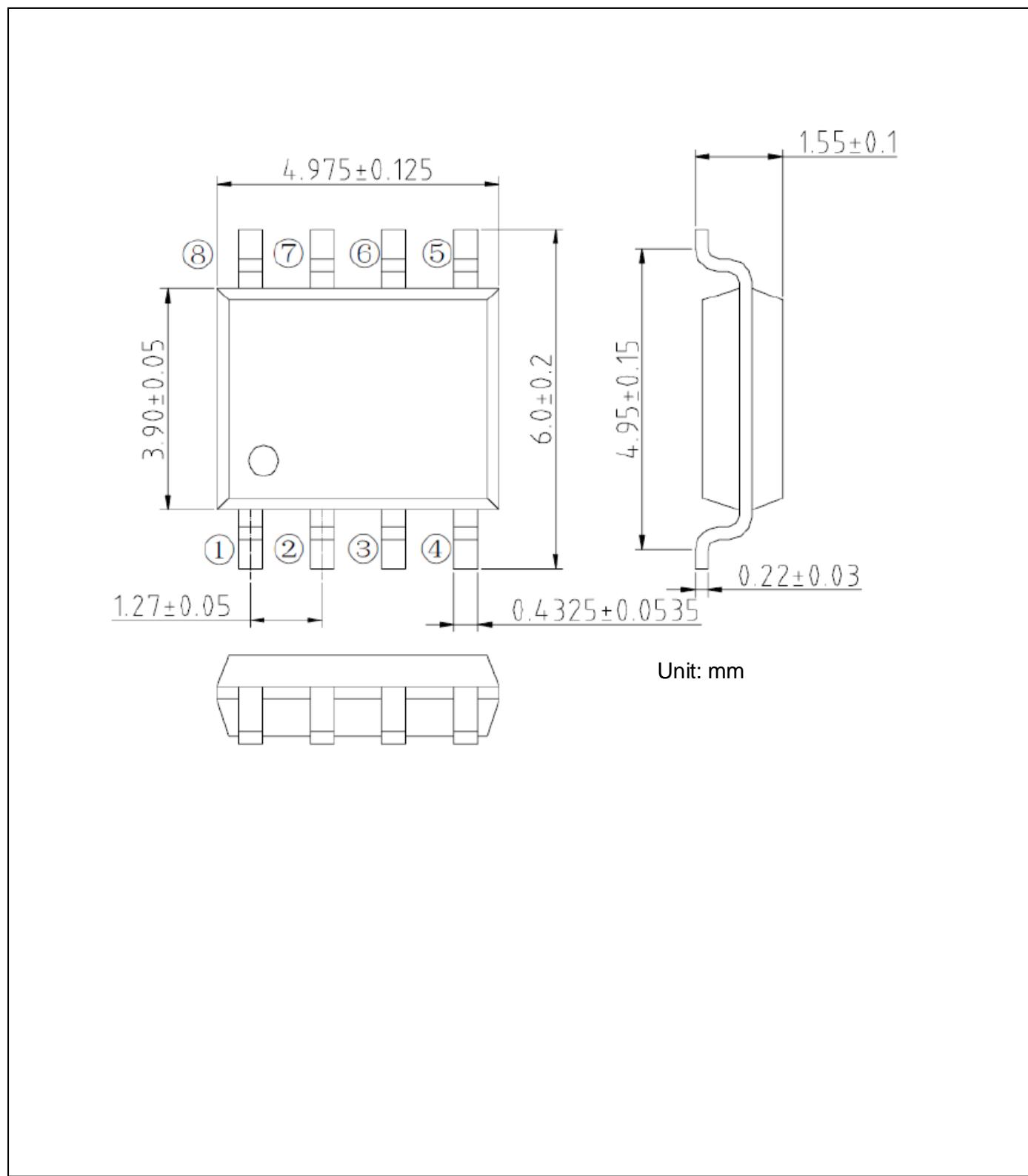
Figure 14 Normalized Maximum Transient Thermal Impedance



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Packing Information

SOP-8





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Notes

ACE does not assume any responsibility for use as critical components in life support devices or systems without the express written approval of the president and general counsel of ACE Electronics Co., LTD. As sued herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.